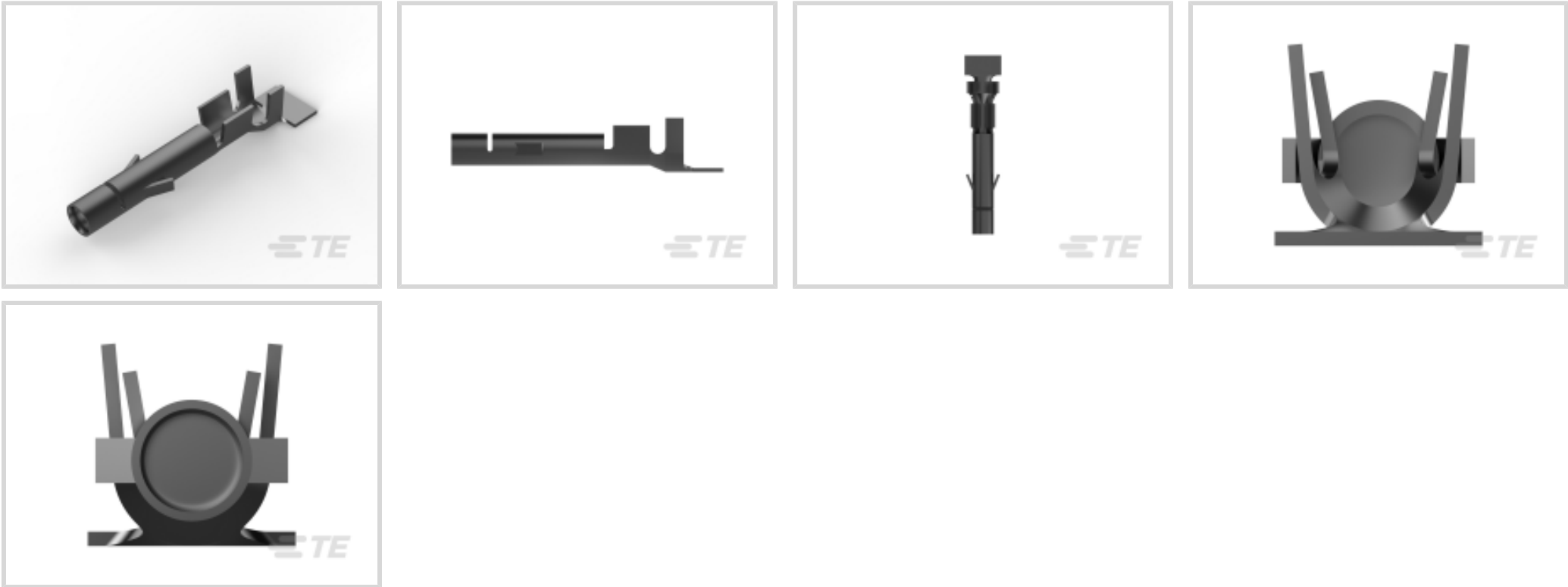




Connectors > Power Connectors > Power Contacts



Operating Voltage: **600 VAC**
Contact Mating Area Plating Material: **Tin**
Wire Size: **.5 – 2.1 mm²**
Connector & Contact Terminates To: **Wire & Cable**

Features

Product Type Features

Compatible With Discrete Wire Type	Stranded
Connector & Contact Terminates To	Wire & Cable

Electrical Characteristics

Operating Voltage	600 VAC
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Contact Features

Contact Shape & Form	Split
Contact Mating Area Plating Material	Tin
Contact Current Rating (Max)	19 A
Contact Type	Socket
Contact Retention Within Housing	With
Mating Pin Diameter	2.06 mm[.081 in]
Contact Base Material	Brass
Wire Contact Termination Area Plating Material	Tin
Wire Contact Termination Area Plating Material Finish	Bright
Contact Orientation	Straight



Termination Features

Termination Method to Wire & Cable	Crimp
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Mechanical Attachment

Contact Retention Type Within Housing	Locking Lance
Wire Insulation Support	Without

Dimensions

Wire Size	.5 – 2.1 mm²
Compatible Insulation Diameter Range	3.3 mm[.13 in]

Usage Conditions

Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
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Operation/Application

Circuit Application	Power
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Industry Standards

CSA Rating	Certified, LR 7189
UL Rating	Recognized
Agency/Standard	CSA, UL, VDE

Packaging Features

Packaging Quantity	2000
Packaging Method	Bag

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability